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Part Number: 5030951200
Status: Active
Overview: iGrid Wire-to-Board Dual-Row System
Description: 2.00mm Pitch iGrid Wire-to-Board Crimp Terminal, Female, Pre-plated Gold(Au) Plating, 26-28 AWG, Reel



Series image - Reference only

Documents:

- Drawing (PDF)
- Product Specification 5016460000-PS-000 (PDF)
- Packaging Specification 5030959200-SPK-200 (PDF)
- RoHS Certificate of Compliance (PDF)
- Product Literature (PDF)

General

Product Family

Series

Application

Crimp Quality Equipment

Overview

Product Literature Order No

Product Name

UPC

Crimp Terminals

503095

Signal, Wire-to-Board

Yes

iGrid Wire-to-Board Dual-Row System

987650-1973

iGrid

191128859011

Physical

Durability (mating cycles max)

Gender

Material - Metal

Material - Plating Mating

Material - Plating Termination

Net Weight

Packaging Type

Plating min - Mating

Plating min - Termination

Termination Interface: Style

Wire Insulation Diameter

Wire Size AWG

Wire Size mm²

30

Female

Copper Alloy

Gold

Tin

74.370/mg

Reel

0.200µm

0.889µm

Crimp or Compression

0.85-1.40mm

26, 28

0.079-0.136

Electrical

Current - Maximum per Contact

Voltage - Maximum

2.0A

250V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Crimp Specification

Packaging Specification

Product Specification

Sales Drawing

5016470000-CS-000

5030959200-SPK-200

5016460000-PS-000

5030950000-SD-000

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per
-ED/88/2018 (15
January 2019)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

503095 Series

Use With

501646 Receptacle Housing

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